### **LED Driver Datasheet**

**NU514** 

2020/04/21

#### 4 channel constant current LED driver

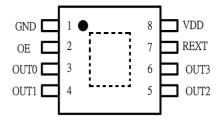
#### **Features**

- 4 constant current sink outputs
- 12 ~ 90mA channel sink current
- 3V to 5.5V supply voltage
- Excellent current sink uniformity channel to channel:  $< \pm 3\%$ chip to chip:  $< \pm 4\%$
- OE pulse width: 120ns
- Schmitt trigger input
- 165°C thermal shutdown protect
- 5ns output group delay for stagger output
- Maximum output voltage: 30V
- $-40^{\circ}$ C ~  $+85^{\circ}$ C operating temperature

# **Package Type**

ESOP8

(Part No.: NU514ES)



### **Product Description**

NU514 is a 4 channels constant current sink driver used for LED lighting. NU514 can sink 4 channels constant current simultaneously by the control of a single OE pin. The sink current of output channels can be set easily by an external resistor Rext. Each output channel can be connected with each other to gain higher current driving capability. With this parallel-able output capability, one NU514 can drive constant current from 12mA to 360mA being used to most types of LEDs.

## **Terminal Description**

Pin name	Function				
$V_{DD}$	5V/3.3V power supply				
GND	Chip ground pin				
R <sub>EXT</sub>	Current setting resistor				
OE	Output enable				
OUT0 ~ OUT3	Constant current sink terminals				
Thermal pad	Chip ground pin potential				

### **Applications**

- General LED Lighting
- Decoration lighting for architecture
- LCD back lighting
- Street lamp

#### **Protection Circuit**

3KV output channel ESD protection

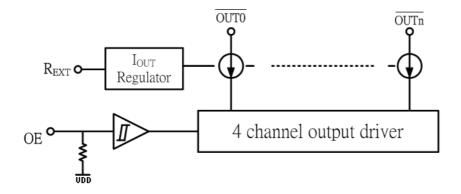
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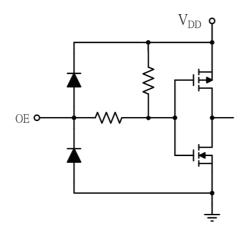
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## **Block Diagram**



# **Equivalent Circuits for OE Input**



# Maximum Ratings (T = 25°C)

Characteristic	Symbol	Rating	Unit	
Supply voltage	$V_{DD}$	0~6.0	V	
Input pin voltage	V <sub>IN</sub>	-0.2 ~ V <sub>DD</sub> +0.2	V	
Output current	I <sub>OUT</sub>	100	mA/Channel	
Output voltage	V <sub>OUT</sub>	-0.2 ~ 30.0	V	
Total GND terminals current	I <sub>GND</sub>	400	mA	
Power Dissipation (On PCB)	PD	1	W	
Thermal Resistance	$R_{TH(j-a)}$	100	°C /W	
Junction temperature	T <sub>j</sub>	170	°C	
Operating temperature (Ambient)	$T_{OPR}$	-40 ~ +85	°C	
Storage temperature	T <sub>STG</sub>	-55 ~ +150	°C	

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# **Electrical Characteristics and Recommended Operating Conditions**

Characte	eristic	Symbol	Condition	Min.	Тур. Мах.		Unit	
Supply vo	oltage	$V_{ m DD}$	Room Temp. 4.5		5	5.5	V	
	Output port sustaining voltage		-	-	-	30	V	
Output cu	ırrent	$I_{OUT}$	OUTn = 1V	12	-	90	mA	
Output lea	Output leakage		$V_0 = 7V$ and channel off	-	-	0.1	uA	
Channel curr (Outpu		$dI_{OUT1}$	$I_{OUT} = 80 \text{mA}, V_{OUT} = 1 \text{V}$	-	±1	±3	%	
Center curre (IC)		dI <sub>OUT2</sub>	$I_{OUT} = 80 \text{mA}, V_{OUT} = 1 \text{V}$	-	-	±4	%	
Line regu	lation	$\%/dV_{DD}$	$R_{\rm EXT} = 900 \Omega$ , $V_{\rm OUT} = 1V$	-	±0.5	±1	%	
Load regu	Load regulation		$R_{\rm EXT} = 900 \Omega$	-	±0.1	±3	%	
Innut	Input voltage			$0.7V_{DD}$	-	-	V	
Input voi				-	-	$0.3V_{\mathrm{DD}}$	V	
Thermal protect		$T_{HalfP}$	Half current output	-	135	-	°C	
(Junction tem	(Junction temperature)		All output off	-	165	-	C	
Pull down resi	istor (OE)	$R_{\mathrm{PU}}$		400 500		700	$K\Omega$	
	All output "Off"	I <sub>DD1(off)</sub>	$R_{EXT}$ = Open, all output off	-	9	-	mA	
		$I_{\mathrm{DD2(off)}}$	$R_{EXT} = 1200 \Omega$ , all output off	-	10	-	mA	
Supply current		$I_{DD3(off)}$	$R_{\rm EXT} = 600 \Omega$ , all output off	-	12	-	mA	
	All output	I <sub>DD1(on)</sub>	$R_{EXT} = 1200 \Omega$ , all output on	-	10	-	mA	
	"On"	I <sub>DD2(on)</sub>	$R_{EXT} = 600 \Omega$ , all output on	-	6	-	mA	

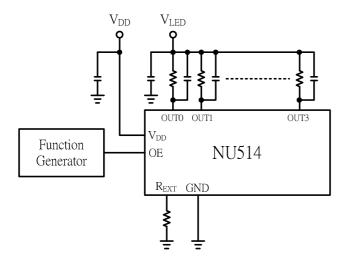
# **Switching Characteristics**

Characteristic	Symbol	Condition	Min.	Тур.	Max.	Unit
Propagation Delay Time (OE from "L" to "H")	t <sub>pLH</sub>	$V_{DD}$ =4V, $V_{OUT}$ =1V, $I_{OUT}$ =80mA, OE= 0V $\rightarrow$ 4V	100	-	250	nS
Output current rising time (OE from "L" to "H")	t <sub>OERise</sub>	$V_{DD}$ =4V, $V_{OUT}$ =1V, $I_{OUT}$ =80mA, OE=0V $\rightarrow$ 4V	100	-	250	nS
Propagation Delay Time (OE from "H" to "L")	t <sub>pHL</sub>	$V_{DD}$ =4V, $V_{OUT}$ =1V, $I_{OUT}$ =80mA, OE=4V $\rightarrow$ 0V	100	-	500	nS
Output current falling time (OE from "H" to "L")	t <sub>OEFall</sub>	$V_{DD}=4V$ , $V_{OUT}=1V$ , $I_{OUT}=80$ mA, $OE=4V \rightarrow 0V$	100	-	250	nS

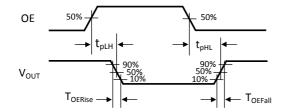
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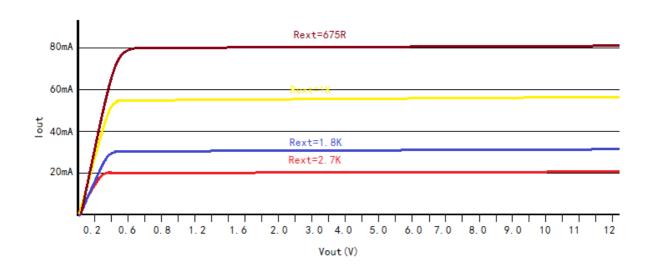
# **Test Circuit for Switching Characteristics**



# **Timing Waveforms**



#### I/V curve



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### **Output Current Setting**

The output current of each channel of NU514 is set by an external resistor ( $R_{EXT}$ ). The relationship between output current and external resistor is shown in the figure or calculated from the equation following.

$$I_{OUT}(A) = \frac{54}{R_{EXT}(\Omega)}$$

Example:  $I_{OUT} = 20 \text{mA}$ 

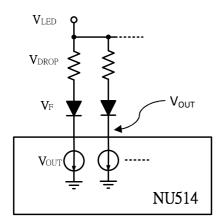
$$0.02(A) \cong \frac{54}{R(\Omega)} \implies R(\Omega) \cong \frac{54}{0.02(A)} \implies 2700(\Omega)$$

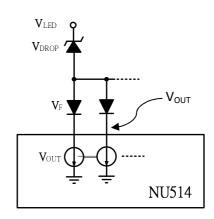
#### **Application Notes**

- In order to maximize the heat dissipation capability and keep the NU514 function normally, the thermal pad under SOP package should be soldered to the PCB and connect to the ground net of system. More the ground area, more the heat dissipation capability that NU514 relies on.
- The V<sub>OUT</sub> should be as low as possible near the knee point of the output I/V curve to minimize the heat generation from NU514.
   An external resistors or zener diodes can be used to minimize V<sub>OUT</sub> in the output current path. The suggestion V<sub>OUT</sub> voltage is between 0.4v to 1v.

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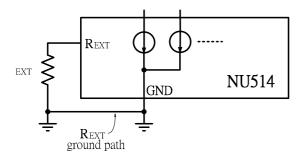
Ex: 
$$V_{OUT} = V_{LED} - (V_{DROP} + V_F)$$



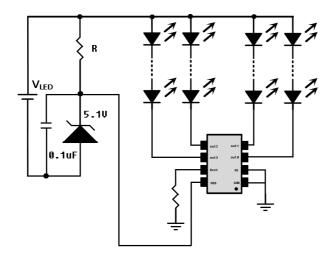


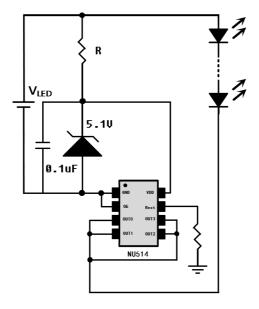
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The R<sub>EXT</sub> ground path should be as short and wide as possible to minimize the chip current skew.

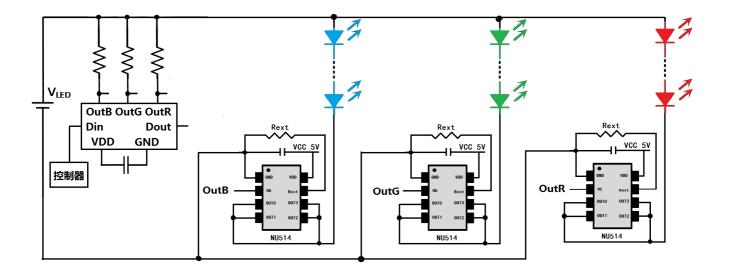


# **Typical Application Circuit**



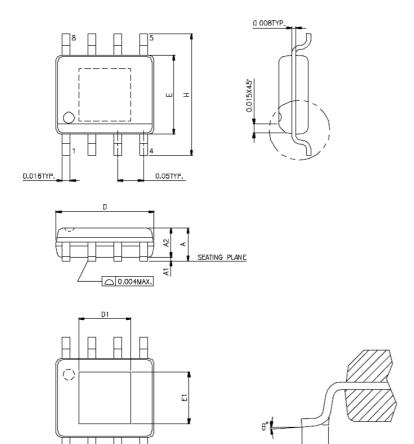


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#### **Package Dimensions**



SYMBOLS	MIN.	MAX.
A	0.053	0.069
A1	0.002	0.006
A2	_	0.059
D	0.189	0.196
E	0.150	0.157
Н	0.228	0.244
L	0.016	0.050
û°	0	8
		LINUT INCL

UNIT: INCH

#### THERMALLY ENHANCED DIMENSIONS

PAD SIZE		E1		D1	
90X	90E	0.081	REF	0.081	REF
95X	130E	0.086	REF	0.117	REF

UNIT: INCH

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